IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

IAP20 Residest/770 10 FEB 2006

Hasso HAIBACH et al.

Application No.: To be assigned (National Phase of PCT/EP2004/007700 filed July 9, 2004)

Filed: February 10, 2006

For: PLATE FOR HOUSING AND/OR LIDS FOR BUTTON CELLS AND PROCESS FOR MANUFACTURING SUCH A PLATE

INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to Rules 56 and 98, Applicants hereby call the attention of the Patent Office to the references listed on the attached Form PTO 1449. These references were cited in an International Search Report (copy enclosed) in a corresponding International Application.

Applicants present these references so that the Patent Office may, in the first instance, determine any relevancy thereof to the presently claimed invention, see <u>Beckman Instruments, Inc. v. Chemtronics, Inc.</u>, 439 F.2d 1369, 1380, 165 USPQ 355, 364 (5th Cir. 1970). Also see Patent Office Rule 104. Applicants respectfully request that these references be expressly considered during the prosecution of this application and made of record herein and appear among the "Reference Cited" on any patent to issue herefrom.

Respectfully submitted,

Date:

By:

APV/pgw

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FORM PTO-1449 U.S. Department of Commerce (Rev. 4/92) Patent and Trademark Office

ATTY. DOCKET NO. APV31920

APPLICATION NO. 7827
To be assigned

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

APPLICANT

Hasso HAIBACH et al.

(Use several sheets if necessary)

FILING DATE

February 10, 2006

GROUP

U.S. PATENT DOCUMENTS

DOCUMENT NUMBER								DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
	5	2	7	9	9	0	5	01/94	Mansfield, Jr. et al.			······································	
	5	5	7	6	1	1	3	11/96	Hirofumi et al.				
	5	7	8	7	7	5	2	08/98	Iwase et al.				
	6	7	3	0	4	3	3	05/04	Buckle et al.				
	6	2	4	5	4	5	2	06/01	Oltmann				
	6	4	3	6	5	7	1	08/02	Passaniti , et al.				
	6	4	6	1	7	6	1	08/02	Moy, et al.				
		5 5 6 6	5 5 5 7 6 7 6 2 6 4	5 2 7 5 5 7 5 7 8 6 7 3 6 2 4 6 4 3	5 2 7 9 5 5 7 6 5 7 8 7 6 7 3 0 6 2 4 5 6 4 3 6	5 2 7 9 9 5 5 7 6 1 5 7 8 7 7 6 7 3 0 4 6 2 4 5 4 6 4 3 6 5	5 2 7 9 9 0 5 5 7 6 1 1 5 7 8 7 7 5 6 7 3 0 4 3 6 2 4 5 4 5 6 4 3 6 5 7	5 2 7 9 9 0 5 5 5 7 6 1 1 3 5 7 8 7 7 5 2 6 7 3 0 4 3 3 6 2 4 5 4 5 2 6 4 3 6 5 7 1	5 2 7 9 9 0 5 01/94 5 5 7 6 1 1 3 11/96 5 7 8 7 7 5 2 08/98 6 7 3 0 4 3 3 05/04 6 2 4 5 4 5 2 06/01 6 4 3 6 5 7 1 08/02	5 2 7 9 9 0 5 01/94 Mansfield, Jr. et al. 5 5 7 6 1 1 3 11/96 Hirofumi et al. 5 7 8 7 7 5 2 08/98 Iwase et al. 6 7 3 0 4 3 3 05/04 Buckle et al. 6 2 4 5 4 5 2 06/01 Oltmann 6 4 3 6 5 7 1 08/02 Passaniti , et al.	5 2 7 9 9 0 5 01/94 Mansfield, Jr. et al. 5 5 7 6 1 1 3 11/96 Hirofumi et al. 5 7 8 7 7 5 2 08/98 Iwase et al. 6 7 3 0 4 3 3 05/04 Buckle et al. 6 2 4 5 4 5 2 06/01 Oltmann 6 4 3 6 5 7 1 08/02 Passaniti , et al.	5 2 7 9 9 0 5 01/94 Mansfield, Jr. et al. 5 5 7 6 1 1 3 11/96 Hirofumi et al. 5 7 8 7 7 5 2 08/98 Iwase et al. 6 7 3 0 4 3 3 05/04 Buckle et al. 6 2 4 5 4 5 2 06/01 Oltmann 6 4 3 6 5 7 1 08/02 Passaniti , et al.	

FOREIGN PATENT DOCUMENTS

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			DOCU	MENT N	UMBER			DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						,						YES	NO
	0	5	6	0	5	7	9	09/93	EP				
	0	6	2	9	0	0	9	12/94	EP				
	0	7	3	2	7	5	8	09/96	EP				
	0	9	4	0	8	6	6	09/99	EP				
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5	5	1	1	9	3	4	5	09/80	JP			Abstract only	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

US Published Patent Application No. 2003/0134191 A1, (Ser. No. 10/051,837), Buckle et al., filed January 16, 2002, published July 17, 2003.

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation is considered, draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.